



Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ (Max.)	I _D (A)	Q _g (Typ.)			
30	0.021 at $V_{GS} = 10 \text{ V}$	12 ^a	3.7 nC			
30	0.033 at $V_{GS} = 4.5 \text{ V}$	6	3.7 110			

FEATURES

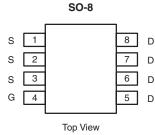
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

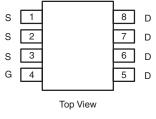


HALOGEN FREE

APPLICATIONS

- · Notebook System Power
- Low Current DC/DC







Ordering Information: Si4128BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	30	V		
Gate-Source Voltage	V_{GS}	± 25			
	T _C = 25 °C		12 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	9.7		
Continuous Brain Current (1) = 100 O)	T _A = 25 °C	טי	8.3 ^{b, c}		
	T _A = 70 °C	1	6.7 ^{b, c}	Α	
Pulsed Drain Current (t = 300 μs)		I _{DM}	40	^	
Ocation of Community Division Division Community	T _C = 25 °C	l _a	4.2		
Continuous Source-Drain Diode Current	T _A = 25 °C	- I _S	2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10		
Single Pulse Avalanche Energy		E _{AS}	5	mJ	
	T _C = 25 °C	P _D	5		
Maximum Power Dissipation	T _C = 70 °C		3.2	W	
waximum Fower Dissipation	T _A = 25 °C		2.4 ^{b, c}	VV	
	T _A = 70 °C		1.5 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	42	53	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	19	25	0/ • •		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 85 °C/W.

Si4128BDY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I = 250 HA		25		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{D} = 250 \mu A$		- 6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.4		2.8	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA	
7 0	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
		$V_{GS} = 10 \text{ V}, I_D = 8.4 \text{ A}$		0.017	0.021	<u> </u>	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 2 \text{ A}$		0.027	0.033	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 8.4 A		22		S	
Dynamic ^b				<u> </u>	I		
Input Capacitance	C _{iss}			405		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C _{rss}			56			
Total Cata Charge	Total Gate Charge $Q_g = V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ C}$	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.4 \text{ A}$		7.5	12	12 5.6 nC	
Total Gate Charge				3.7	5.6		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 8.4 \text{ A}$		1.6			
Gate-Drain Charge	Q_{gd}			1.3			
Gate Resistance	R_{g}	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		15	25	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7~A,~V_{GEN}=4.5~V,~R_g=1~\Omega$		11	20		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			7	15		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 2.2 \Omega$		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7~A,~V_{GEN}$ = 10 V, R_g = 1 Ω		12	20		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			4.2	A	
Pulse Diode Forward Current	I _{SM}				40	^	
Body Diode Voltage	V_{SD}	$I_S = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 6.7 A, dl/dt = 100 A/μs, T _J = 25 °C		8	16	nC	
Reverse Recovery Fall Time	t _a	1 _F = 0.7 Λ, αι/αι = 100 Α/μs, 1 _J = 25 °C		8.5			
Reverse Recovery Rise Time	t _b			6.5		ns	

Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

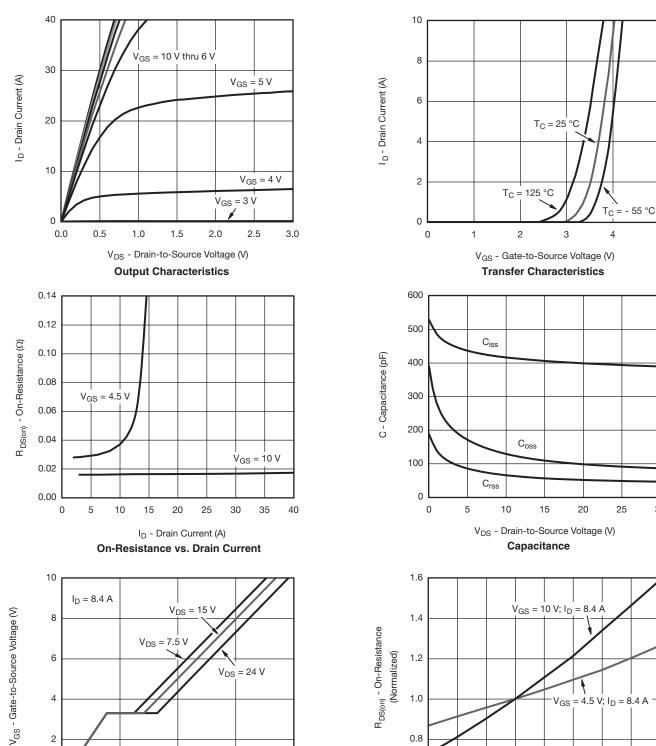
5

30



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Document Number: 63584 S11-2183-Rev. A, 07-Nov-11

2

0

125

150

0.8

0.6 - 50

50

T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

75

100

25

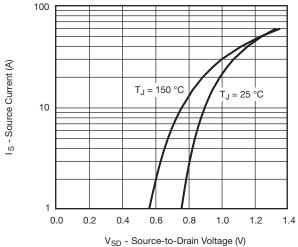
Q_g - Total Gate Charge (nC)

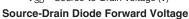
Gate Charge

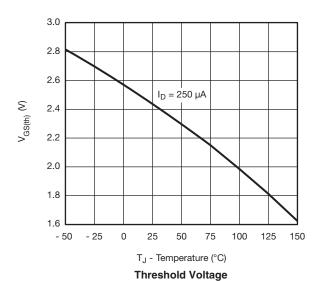
Si4128BDY

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

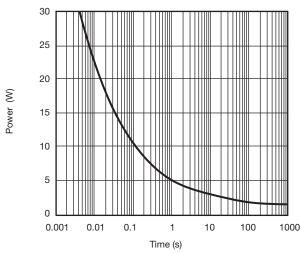




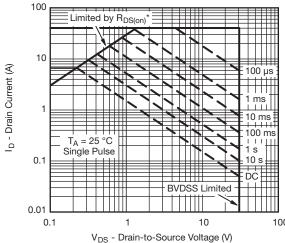


0.050 0.045 R_{DS(on)} - On-Resistance (Ω) 0.040 0.035 = 8.4 A; T_J = 125 °C 0.030 $I_D = 8.4 \text{ A}; T_J = 25 \,^{\circ}\text{C}$ 0.025 0.020 $I_D = 2 A; T_J = 25 °C$ 0.015 0.010 0 8 10 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



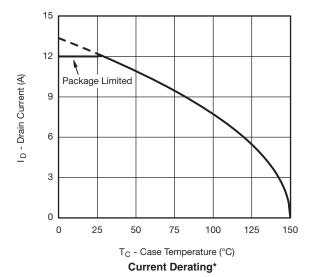
 * V $_{GS}$ > minimum V $_{GS}$ at which R $_{DS(on)}$ is specified

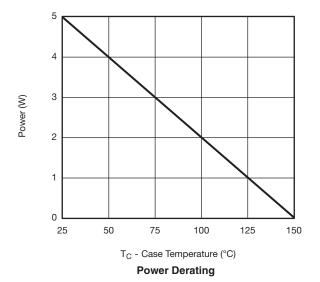
Safe Operating Area, Junction-to-Ambient



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





 $^{^*}$ The power dissipation P_D is based on $T_{J(max.)}$ = 150 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4128BDY

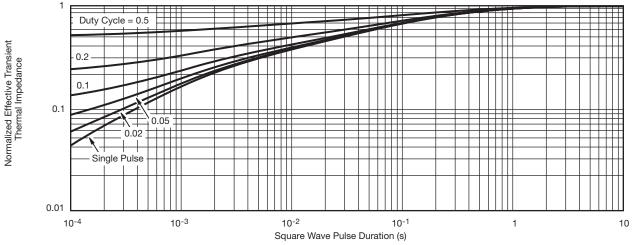
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

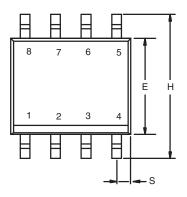


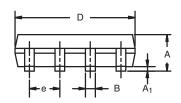
Normalized Thermal Transient Impedance, Junction-to-Foot

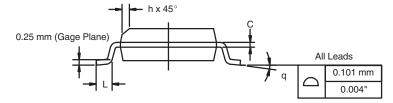
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63584.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







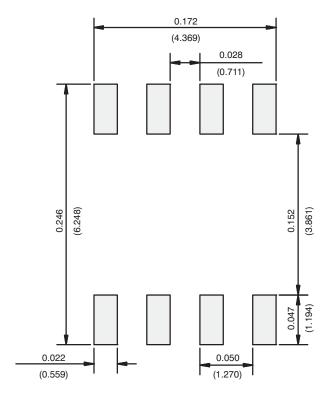
	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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